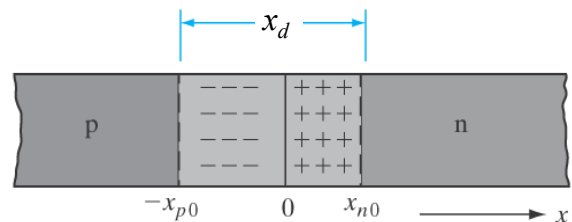


ECE 116 Lectures 22-23

Current Flow in “ideal” P-N diode

- https://truenano.com/PSD20/chapter4/ch4_4.htm
- Read Ch. 4.4 to 4.4.2.4
- Skim 4.4.4 (“real” diodes, more on this in EE 216)
- Note: “long” diode, i.e. size of diode \gg diffusion length
($W_n, W_p \gg L_p, L_n$)

- Until now, we talked about unbiased P-N junction.
- Today, biased ($V_A \neq 0$) P-N junction and current flow

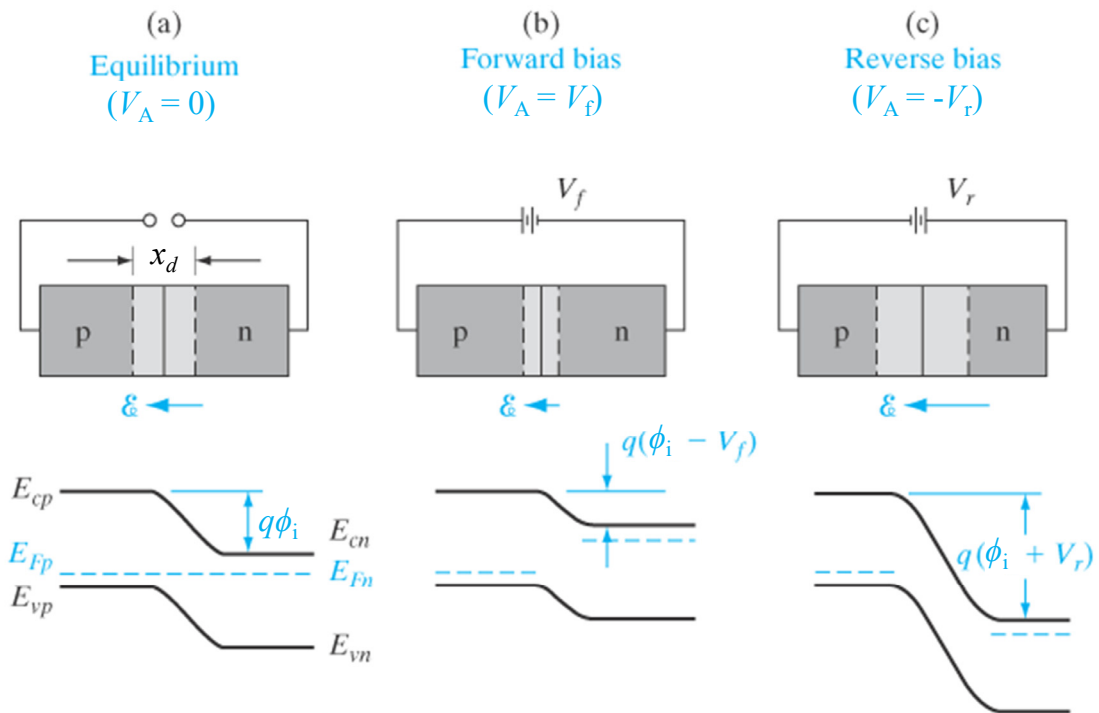


- Draw equilibrium ($V = 0$) bands:

- Recall built-in voltage and depletion width:

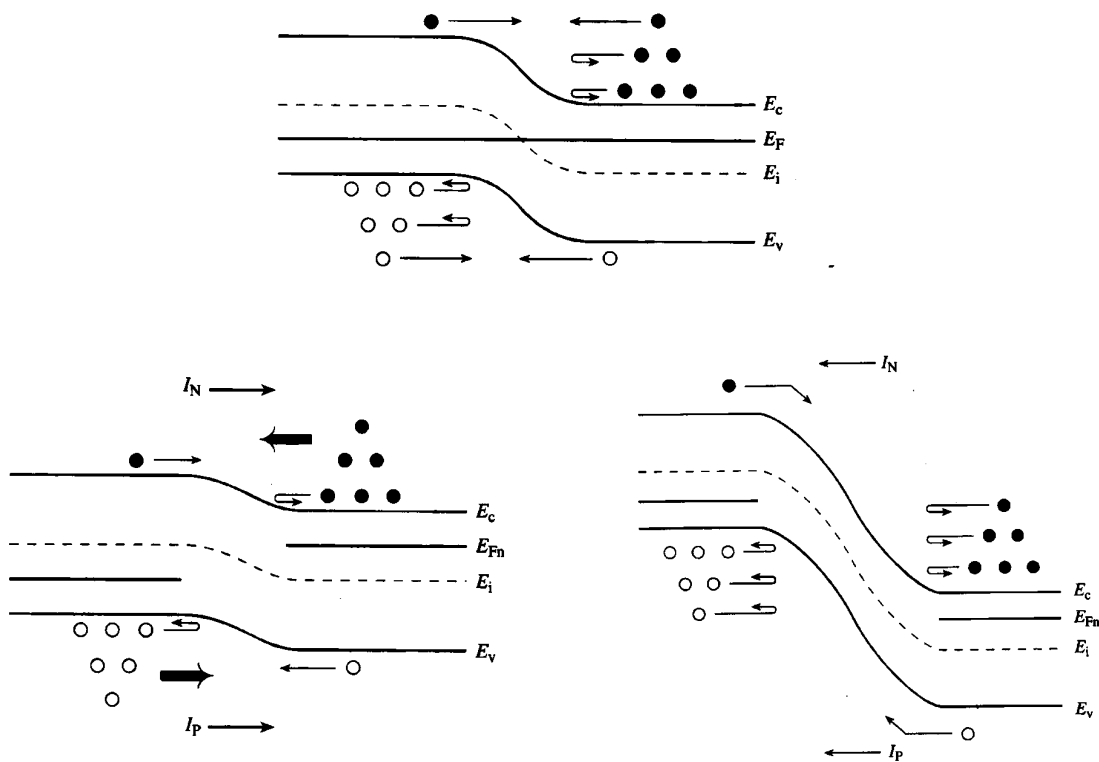
$$\phi_i = \frac{kT}{q} \ln \left(\frac{N_A N_D}{n_i^2} \right)$$
$$x_d = x_n + x_p = \sqrt{\frac{2\epsilon_s}{q} \left(\frac{1}{N_A} + \frac{1}{N_D} \right) (\phi_i - V)}$$

- Qualitative band diagrams with applied voltage:



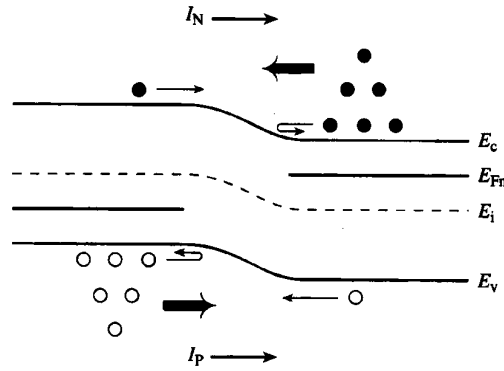
- Current flow in equilibrium ($V = 0$) $\rightarrow J_{\text{tot}} = 0$

- Qualitative current flow:



- Qualitatively expect I-V curve to be:

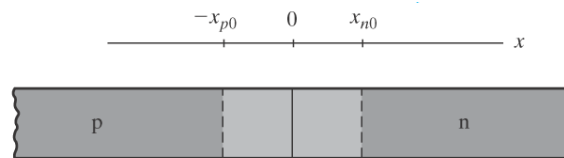
- In forward bias, inside space charge region (SCR):



$$pn = n_i^2 e^{qV/kT}$$

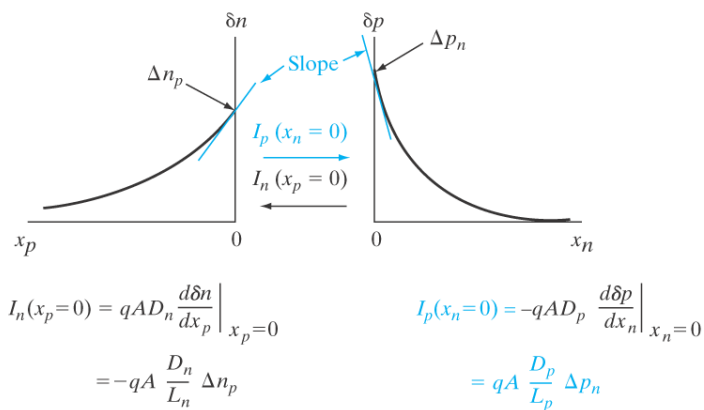
- Where $V=V_A$ is the applied bias and $qV_A = E_{Fn} - E_{Fp}$

- Let's look at the *injected minority carriers* (with lights off)



- On the n-side, injected holes $\rightarrow \delta p(x)$
- Just at the edge of n-side depletion region:

(a)



$$n_n(x_{n0}) = N_D$$

$$p_n(x_{n0}) = (n_i^2/N_D)e^{qV/kT}$$

$$\Delta p_n(x_{n0}) = (n_i^2/N_D)(e^{qV/kT} - 1)$$

- Excess injected holes diffuse into the n-side:

$$\delta p_n(x) = \Delta p_{n0} e^{-x/L_p} = p_{n0} (e^{qV/kT} - 1) e^{-x/L_p}$$

(same is true of excess injected electrons on p-side).

- Injected hole diffusion current:

$$J_p = -qD_p \left[\frac{d}{dx} \delta p_n(x') \right] = q \frac{D_p}{L_p} p_{n0} (e^{qV/kT} - 1) e^{-x/L_p}$$

- Where equilibrium hole concentration $p_{n0} = n_i^2/N_D$
(and similar for injected electron diffusion on p-side, just replace subscripts p with n)

- Hole diffusion current proportional to excess hole concentration at any distance x into the n-type region.
- Due to hole current continuity, we can evaluate at $x=x_{n0}=0$

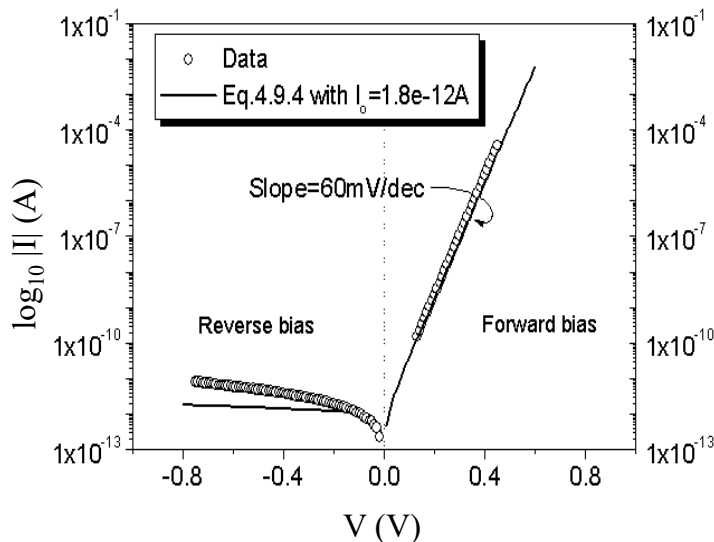
$$J_p = q \frac{D_p}{L_p} \frac{n_i^2}{N_D} (e^{qV/kT} - 1)$$

- We can also write diffusion current for electrons in p-side:

$$J_n = q \frac{D_n}{L_n} \frac{n_i^2}{N_A} (e^{qV/kT} - 1)$$

- Now total current $J = J_n + J_p$

so finally $\rightarrow J = qn_i^2 \left[\frac{D_n}{L_n N_A} + \frac{D_p}{L_p N_D} \right] (e^{qV/kT} - 1)$



This is the SPICE-level model



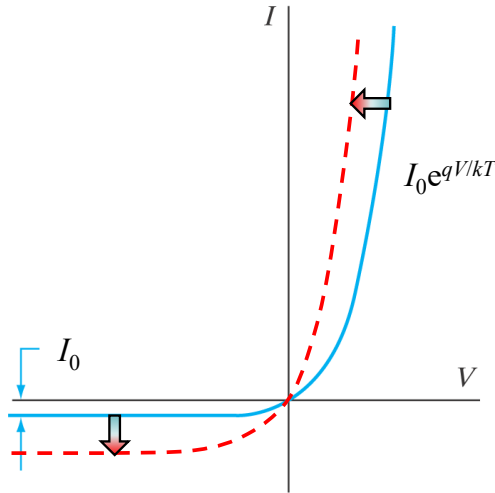
Some “knobs” for engineering pn diodes:

- Doping (N_A, N_D) and material (μ, E_G)

$$I = I_0(e^{qV/kT} - 1)$$

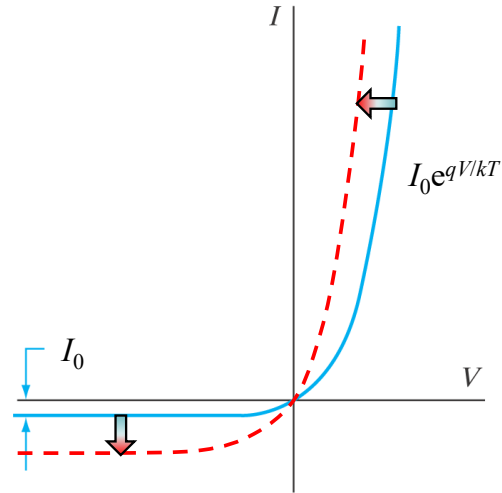
$$I_0 = Aqn_i^2 \left(\frac{D_p}{L_p N_d} + \frac{D_n}{L_n N_a} \right)$$

Decrease Doping



$$N_D, N_A > N_D', N_A'$$

Increase Temperature



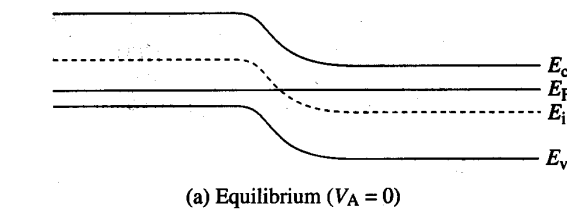
$$T < T'$$

EE 116 Lectures 24-25

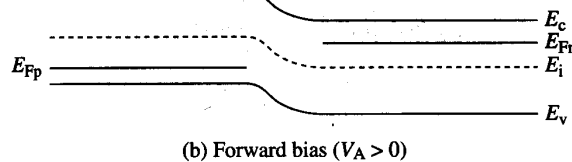
P-N diode carrier injection; reverse bias

Recap diode bias diagrams:

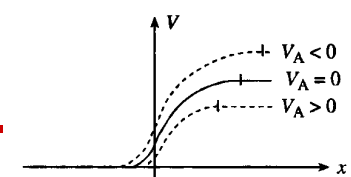
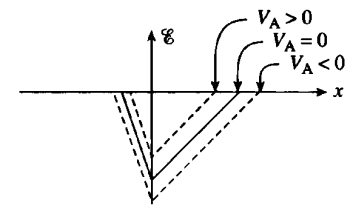
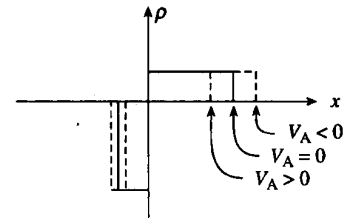
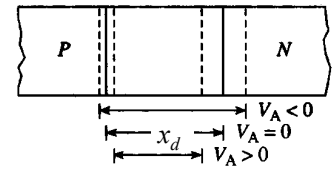
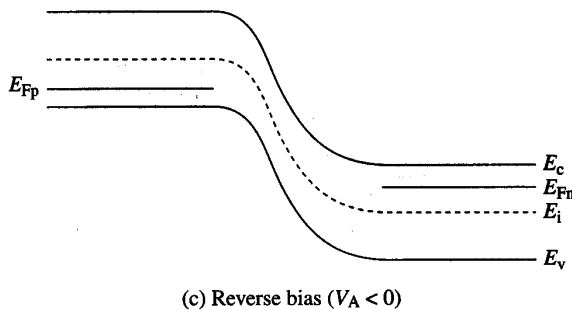
a) equilibrium



b) forward bias ($V > 0$)



c) reverse bias ($V < 0$)



- Recap some of the equations:

- Depletion width

$$x_d = x_n + x_p = \sqrt{\frac{2\epsilon_s}{q} \left(\frac{1}{N_A} + \frac{1}{N_D} \right) (\phi_i - V)}$$

(decreases at forward bias,
increases at reverse bias)

$$x_n = \frac{N_A}{N_A + N_D} x_d \quad x_p = \frac{N_D}{N_A + N_D} x_d$$

- Maximum electric field

(decreases at forward bias,
increases at reverse bias)

$$E_{\max} = E_0 = \frac{2(\phi_i - V)}{x_d}$$

- Built-in voltage

$$\phi_i - V =$$

- Charge stored

- Current density (current $I = J \cdot A$)

$$J = qn_i^2 \left[\frac{D_n}{L_n N_A} + \frac{D_p}{L_p N_D} \right] (e^{qV/kT} - 1)$$

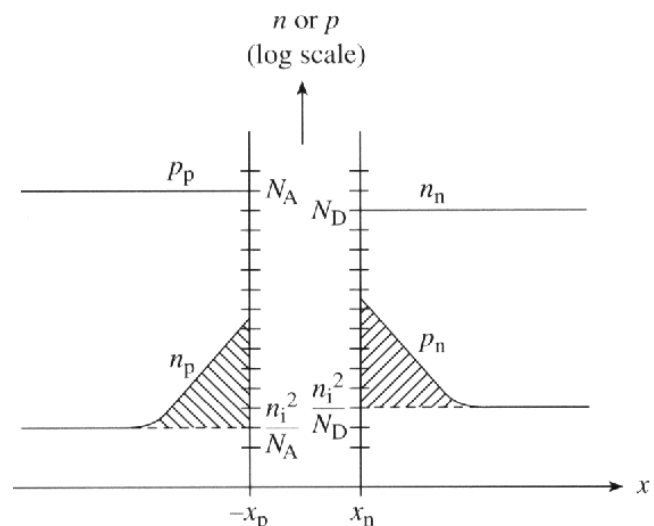
- What about an asymmetrically doped junction? Say, p side much more heavily doped ($N_A \gg N_D$):

- Remember, current is due to minority carrier injection

- Typically p-n junctions in real life are made by counterdoping. E.g. start with p-type wafer and dope with N_D only at the surface to obtain junction. Eqs. so far readily apply if

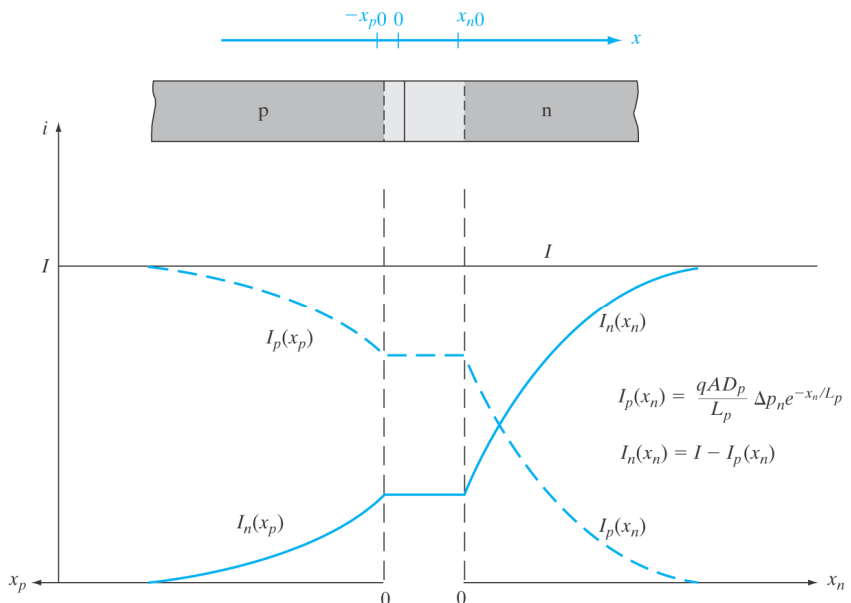
- N_A = net doping on p-side = $(N_A - N_D)_{\text{p-side}}$

- N_D = net doping on n-side = $(N_D - N_A)_{\text{n-side}}$



- **Ex:** a p-n junction has $N_A=10^{19} \text{ cm}^{-3}$ and $N_D=10^{16} \text{ cm}^{-3}$. The applied voltage is 0.6 V. a) What are the minority carrier concentrations at the edges of the depletion region? b) What are the excess minority carrier concentrations? c) Sketch $\delta n(x)$ on the p-side if recombination lifetime is $2 \mu\text{s}$.

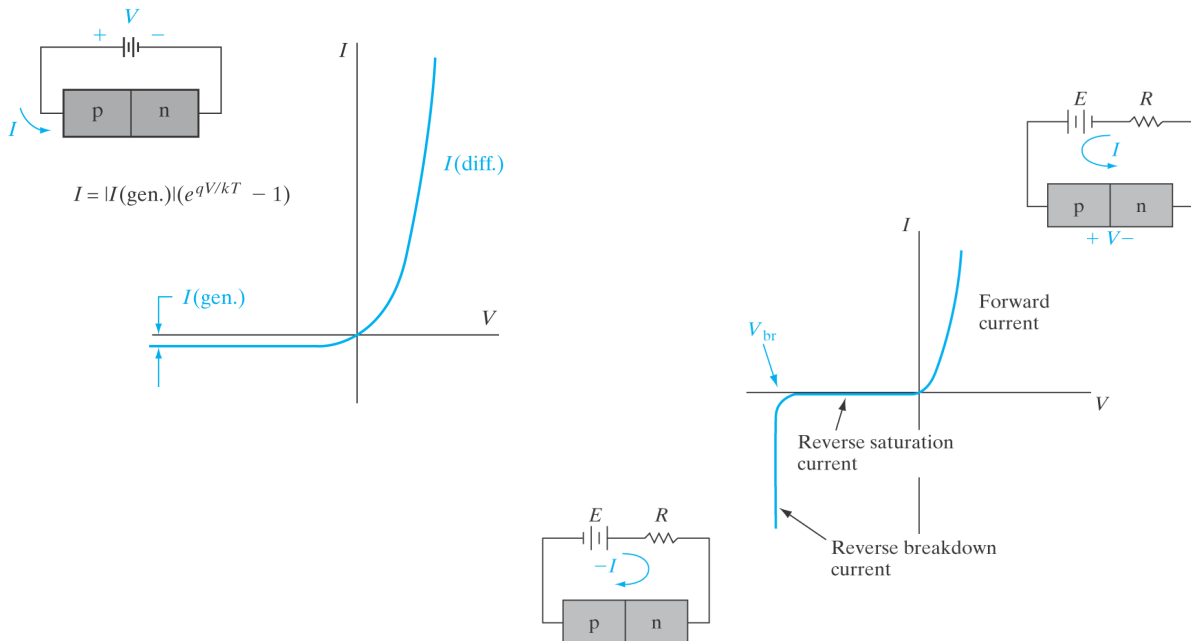
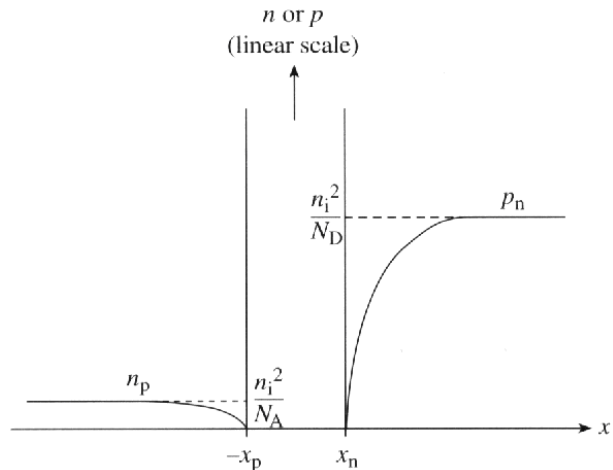
- Current continuity along junction length, $J_{\text{TOT}} = \text{const.}$
- As carriers recombine (deep into n- or p-side) the diffusion current is replaced by



- But, we were able to deduce current equation by simple diffusion arguments at the _____ where the E-field was just barely zero.

- Reverse bias:

- Depletion region widens
- E-field across depletion region _____
- Current is due only to minority carrier _____ across the junction
- Current is supplied by EHP generation in the _____ (what if I change the temperature or turn on the light?)
- Recall, $J_0 \propto n_i^2$

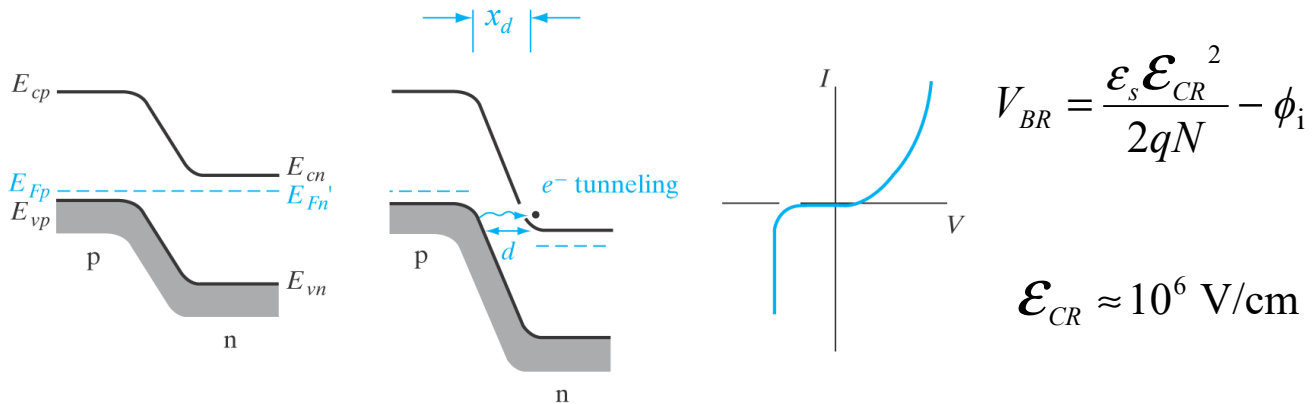


- Junction breakdown when E-field exceeds a critical value. If current continues increasing, then diode _____ .

Reverse Bias P-N Breakdown (3 types)

1) Zener breakdown:

- Dominant for heavily doped ($>10^{18} \text{ cm}^{-3}$) p+n+ diodes
- Breakdown at a few Volts (typically $< 5 \text{ V}$)



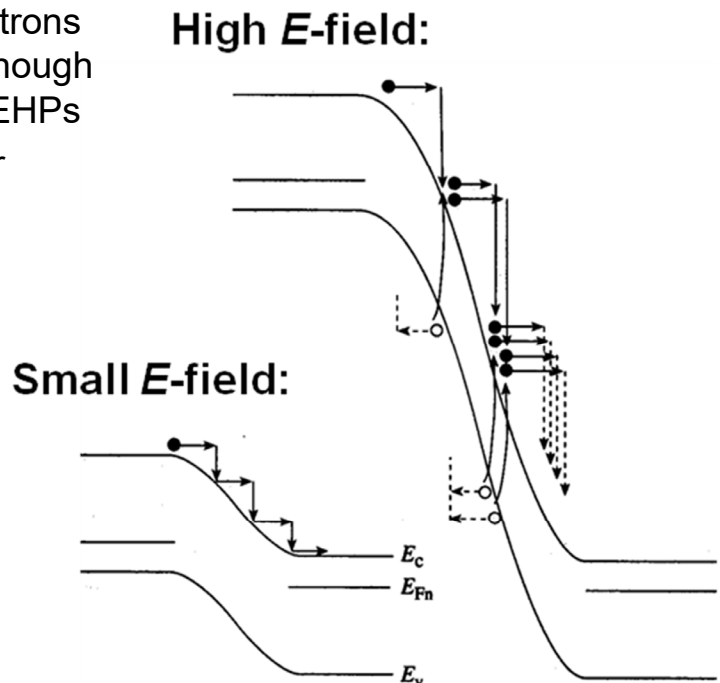
- Electron tunneling from filled valence states on p-side into (mostly) empty conduction band states on n-side

2) Avalanche breakdown

- More lightly doped junctions ($<10^{17} \text{ cm}^{-3}$)
- Wider depletion region, electrons accelerated across it gain enough energy to create additional EHPs
- Impact ionization and carrier multiplication

$$V_{BR} \approx \frac{\epsilon_s \mathcal{E}_{CR}^2}{2qN}$$

if $V_{BR} \gg \phi_i$



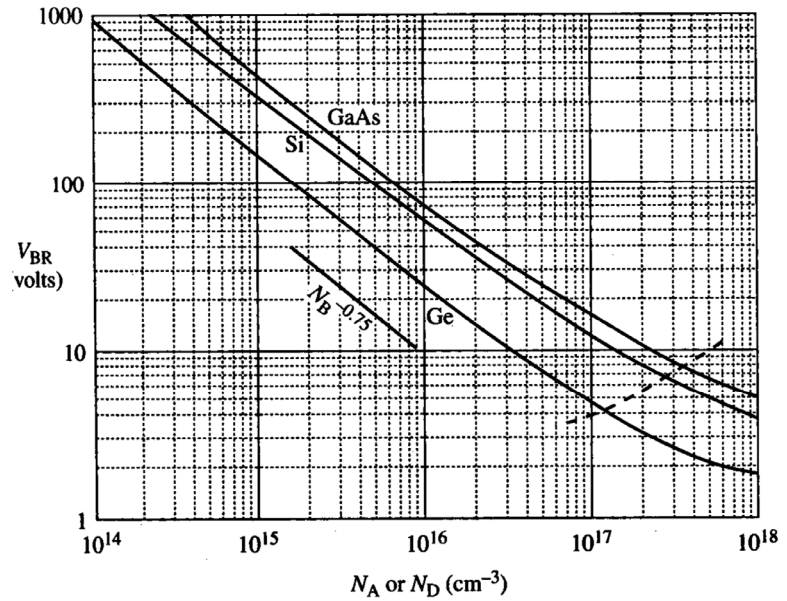
- Empirical observation of V_{BR} with doping and material

- V_{BR} decreases with increasing N ($=N_A$ or N_D)
 - V_{BR} decreases with decreasing E_G

- V_{BR} dependence on temperature:

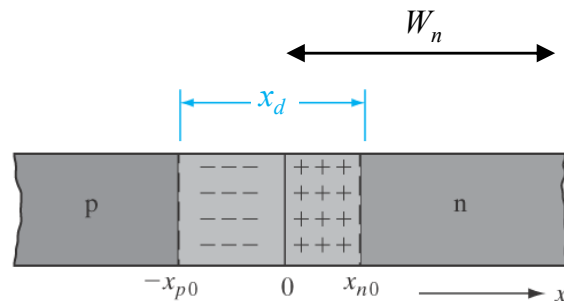
- For tunneling (Zener) breakdown...

- For avalanche breakdown...



3) Punchthrough breakdown:

- Occurs when either depletion region “punches through” the entire length of the diode, e.g. $x_n(V) = W_n$



$$x_d = x_n + x_p = \sqrt{\frac{2\epsilon_s}{q} \left(\frac{1}{N_A} + \frac{1}{N_D} \right) (\phi_i - V)}$$

$$x_n = \frac{N_A}{N_A + N_D} x_d; \quad x_p = \frac{N_D}{N_A + N_D} x_d$$